



COPY OF PAPERS
ORIGINALLY FILED

Docket No. 742423-6

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application:) Group: 2833
Kaori YASUFUKU et al.) Examiner: F. Figueroa
Application Serial No.: 09/643,948)
Filed: August 23, 2000)
For: CONNECTOR FOR MODULE)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with The United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231, on March 19, 2002

AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

Responsive to the Office Action of December 19, 2001, the following amendments and remarks are submitted in connection with the above-identified application.

IN THE CLAIMS:

Please amend claims 1 and 20 as follows. Attached hereto is a marked-up copy of the claims in amended form.

1. (Thrice Amended) A connector for a module that connects the module, the module having a semiconductor chip mounted on a rectangular board and a conductive pad on a front side of the board, to a printed circuit board in a position wherein a plane of the board is substantially parallel to the printed circuit board,

said connector comprising:

a connector body having a receiving part that extends along the front side of the module being in a connection position, and a groove provided in a rear face thereof into which the front side of the module is inserted, said groove having contacts provided therein which contact the conductive pad on both a top surface and a bottom surface of the module

#15/c
9-19-02
JWM

RECEIVED
APR - 2 2002
TECHNOLOGY CENTER 2800
Glynis Cantrell

p1
et